Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: <u>ti.com/support</u>

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: 06/13/2022

Details for "UCC27200DRMT"

Current Product Information

	TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
ı	UCC27200DRMT	NIPDAUAG	Level-2-260C-1 YEAR	Ext-Mfg	DRM 8	4x4x0.9	44.3

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.132991	97.666135	976661	0.300261	3003
Precious Metals	Palladium	7440-05-3	0.003178	2.333865	23339	0.007175	72
Sub-Total			0.136169	100	1000000	0.307436	3074
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.42753	79.999925	799999	0.965259	9653
Thermoplastics	Epoxy	85954-11-6	0.106883	20.000075	200001	0.241316	2413
Sub-Total			0.534413	100	1000000	1.206574	12066
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	20.680666	97.440002	974400	46.691909	466919
Copper and Its Alloys	Iron	7439-89-6	0.498764	2.35	23500	1.126088	11261
Copper and Its Alloys	Phosphorus	7723-14-0	0.016979	0.079999	800	0.038334	383
Zinc and Its Alloys	Zinc	7440-66-6	0.027591	0.129999	1300	0.062294	623
Sub-Total			21.224	100	1000000	47.918625	479186
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.128144	97.299924	972999	0.289318	2893
Precious Metals	Gold	7440-57-5	0.000395	0.299924	2999	0.000892	9
Precious Metals	Palladium	7440-05-3	0.002766	2.100228	21002	0.006245	62
Precious Metals	Silver	7440-22-4	0.000395	0.299924	2999	0.000892	9
Sub-Total			0.1317	100	1000000	0.297347	2973
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	18.383121	90.499999	905000	41.504612	415046
Other Plastics and Rubber	Carbon Black	1333-86-4	0.101564	0.499999	5000	0.229307	2293
Thermoplastics	Ероху	85954-11-6	1.828156	9.000002	90000	4.127531	41275
Sub-Total			20.312841	100	1000000	45.86145	458614
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	1.952632	100	1000000	4.408568	44086
Sub-Total			1.952632	100	1000000	4.408568	44086
Total			44.291755			100	1000000

Important Not

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

Tl certifies that the material content information provided by Tl is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. Tl semiconductor products designated to be "Pb-free", "Green" or "ROHS Exempt" fully meets the latest EU ROHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Thases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. Timay not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Ti and Ti suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by Ti. The material content information is provided by Ti. "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/13/2022

ROHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

ROHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.